

**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	ULTRA-LOW IMPEDANCE POWER INTERCONNECTION SYSTEM FOR ELECTRONIC PACKAGES									
Application Number: 10/036957 Date: 2001-12-20 First Named Applicant: Mr. Joseph T. DiBene II. Confirmation Number: 4590 Attorney Docket Number: INCEP.017A										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Raymond B. Hom Registered Number: 44,773</td><td>/rbh/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Raymond B. Hom Registered Number: 44,773	/rbh/	Attorney		
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